

LV4045BCT-LV4060BCT

Rev.E May.-2016

描述 / Descriptions

TO-263 塑封封装 肖特基二极管。

Schottky Barrier Diode in a TO-263 Plastic Package.

特征 / Features

低正向压降，低功耗损失，效率高。

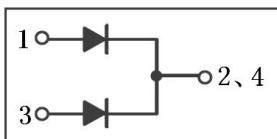
Low forward voltage drop, low power losses, High efficiency operation.

用途 / Applications

用于高频率逆变器，开关电源，续流二极管，OR-ing 二极管，DC-DC 转换器和电池反向保护。

For use in high frequency inverters, switching power supplies, freewheeling diodes, OR-ing diode, dc-to-dc converters and reverse battery protection.

内部等效电路 / Equivalent Circuit



引脚排列 / Pinning



PIN1: Anode PIN 2、4: Cathode PIN 3: Anode

放大及印章代码 / h_{FE} Classifications & Marking

见印章说明。See Marking Instructions.

极限参数 / Absolute Maximum Ratings(Ta=25°C)

参数 Parameter	符号 Symbol	数值 Rating			单位 Unit
		LV4045BCT	LV4050BCT	LV4060BCT	
Peak Repetitive Reverse Voltage	V_{RRM}	45	50	60	V
RMS Reverse Voltage	V_{RMS}	32	35	42	V
Average Rectified Output Current	I_O	40			A
Non-Repetitive Peak Forward Surge Current	I_{FSM}	300			A
Average forward current	$I_{F(AV)}$	2×20			A
Non-Repetitive Peak Forward Surge Current	I_{FSM}	300			A
Thermal Resistance Junction to Ambient case	$R_{\theta Jc}$	1.8			°C/W
Operating and Storage Temperature Range	T_j T_{stg}	-55~+150			°C

电性能参数 / Electrical Characteristics(Ta=25°C)

参数 Parameter	符号 Symbol	测试条件 Test Conditions	数值 Rating			单位 Unit
			LV4045BCT	LV4050BCT	LV4060BCT	
Reverse Breakdown Voltage	V_{BR}	$I_R=1mA(Ta=25^\circ C)$	45	50	60	V
Forward Voltage	V_F	$I_F=10A(Ta=25^\circ C)$	470		500	mV
		$I_F=20A(Ta=25^\circ C)$	550		600	mV
		$I_F=30A(Ta=25^\circ C)$	700			mV
		$I_F=20A(Ta=125^\circ C)$	600			mV
Instantaneous Reverse current (Note1)	I_R (Note 1)	$V_R=V_{BR}(Ta=25^\circ C)$	500			μA
		$V_R=V_{BR}(Ta=125^\circ C)$	100			mA
Total Capacitance	C_T		1000			pF
Voltage Rate of Change	dV/dt		10000			V/us

注/Notes:

1. 使用极短的测试时间,以尽量减少自热效应。/Short duration pulse test used to minimize self-heating effect.
2. 除非特别注明,数值为一个芯片的参数。/ Unless otherwise noted, values for the parameters of a single chip.

电参数曲线图 / Electrical Characteristic Curve

FIG.1 MAXIMUM FORWARD CURRENT DERATING CURVE

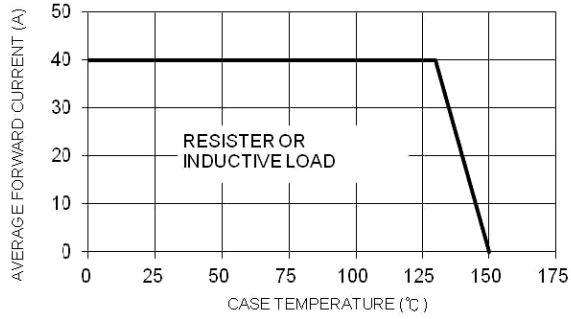


FIG. 2 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT PER LEG

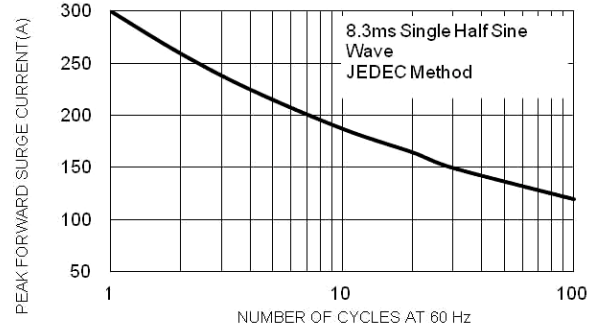


FIG. 3 TYPICAL FORWARD CHARACTERISTICS PER LEG

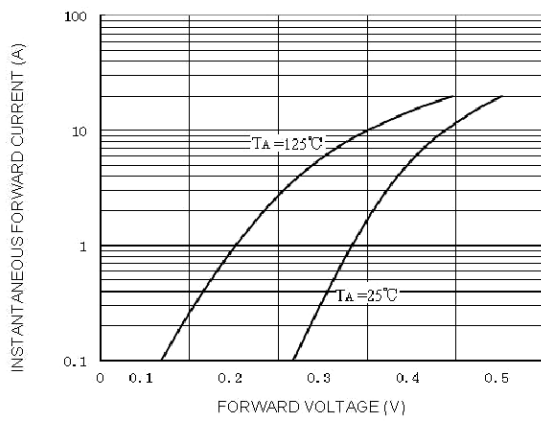
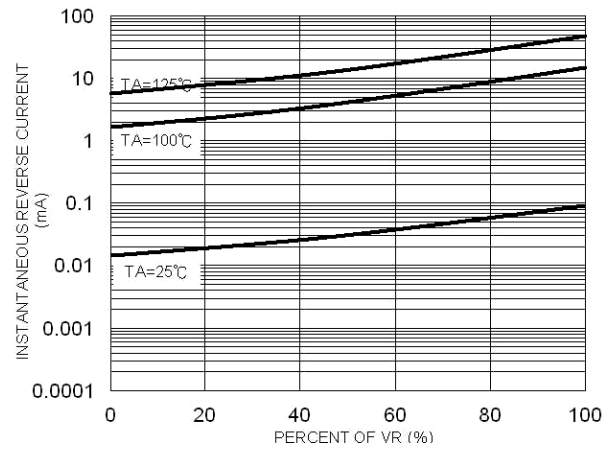
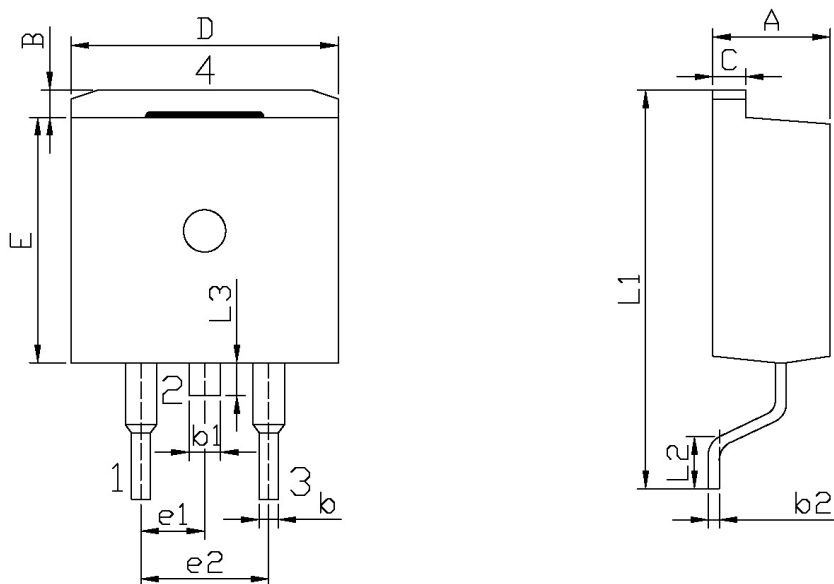


FIG. 4 TYPICAL REVERSE CHARACTERISTICS PER LEG



外形尺寸图 / Package Dimensions

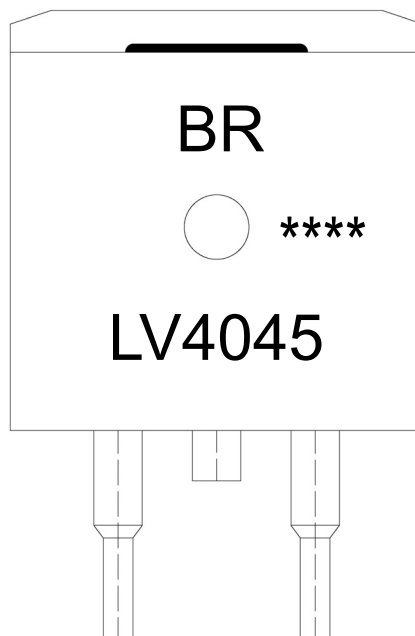


单位: mm

Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
A	4.30	4.70	E	9.00	9.40
B	1.00	1.40	e1	2.34	2.74
b	0.70	0.90	e2	4.88	5.28
b1	1.15	1.35	L1	15.00	16.00
b2	0.40	0.60	L2	2.24	2.84
C	1.20	1.40	L3	1.20	1.60
D	9.80	10.20			

TQ-263

印章说明 / Marking Instructions



说明：

BR： 为公司代码

LV4045： 为产品型号

****： 为生产批号代码，随生产批号变化。

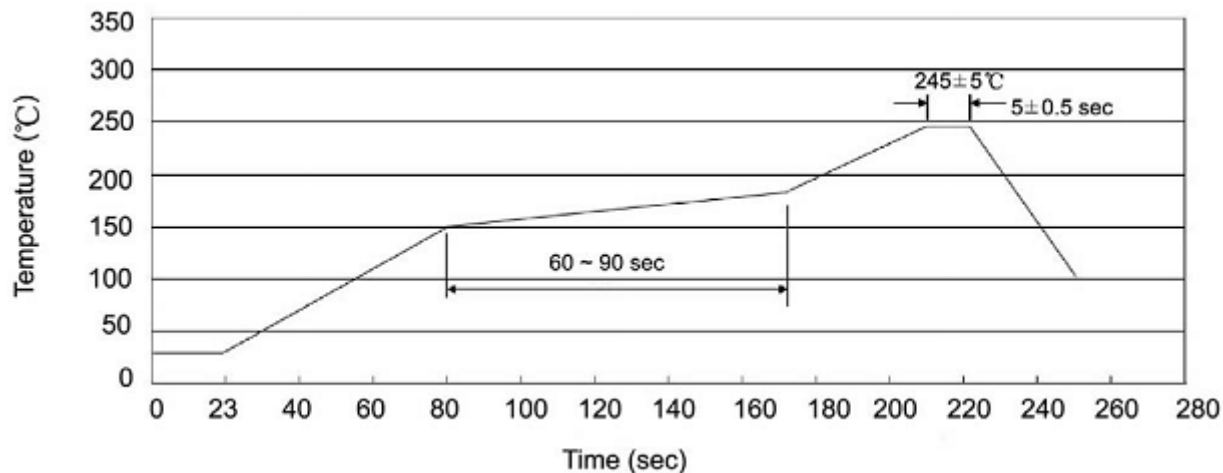
Note:

BR: Company Code.

LV4045: Product Type.

****: Lot No. Code, code change with Lot No.

波峰焊温度曲线图(无铅) / Temperature Profile for Dip Soldering(Pb-Free)



说明：

- 1、预热温度 25 ~ 150°C，时间 60 ~ 90sec;
- 2、峰值温度 245±5°C，时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2 ~ 10°C/sec.

Note:

- 1.Preheating:25~150°C, Time:60~90sec.
- 2.Peak Temp.:245±5°C, Duration:5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions

温度：260±5°C

时间：10±1 sec.

Temp.:260±5°C

Time:10±1 sec

包装规格 / Packaging SPEC.

卷盘包装 / REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
TO-263	800	1	800	5	4,000	13" x24	360×360×50	385×257×392

套管包装 / TUBE

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Tube 只/套管	Tubes/Inner Box 套管/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Tube 套管	Inner Box 盒	Outer Box 箱
TO-263	50	20	1,000	5	5,000	532×33×7.0	555×164×50	575×290×180

使用说明 / Notices